IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Hidehiko KIRA et al.

Serial No. 08/897,953

Filed: July 24, 1997

METHOD AND APPARATUS FOR FABRICATING SEMICONDUCTOR DEVICE

NEC 0 7 1998

REQUEST FOR APPROVAL OF DRAWING CORRECTIONS

Assistant Commissioner of Patents Washington, D.C. 20231

December 7, 1998

Group Art Unit:

Examiner: David E. GRAYBILL

Sir:

For:

The Examiner's approval of the drawing corrections indicated in red ink on the attached 1 sheet of drawings (Figure 3) is respectfully requested.

In Figure 3, include the following phrase in the block box labeled "S6": --AT FIRST FIXING PRESSURE--, as shown in red ink in Figure 3, as attached.

Also, in Figure 3, include the following phrase in block box labeled "S8": -AT SECOND FIXING PRESSURE--, as shown in red ink in Figure 3, as attached.

Upon receipt of approval of the drawing corrections and a formal Notice of Allowance, a bonded draftsman will be retained and the appropriate corrections will be made.

Respectfully submitted,

ARMSTRONG, WESTERMAN, HATTORI, McLELAND & NAUGHTON

Mel R. Quintos

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MRQ:lrj

Attachment: 1 Sheet of Corrected Dwgs (Figure 3) w/corrections in red ink

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